



## Material Content Data Sheet



Halogen-Free

<b>Sales Product Name</b>	BTS436L2G	<b>Issued</b>	17. February 2022
<b>MA#</b>	MA005698771		
<b>Package</b>	PG-TO263-5-2	<b>Weight*</b>	1547.46 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	5.066	0.33	0.33	3274	3274
leadframe	inorganic material	phosphorus	7723-14-0	0.237	0.02		153	
	non noble metal	iron	7439-89-6	0.790	0.05		510	
	non noble metal	copper	7440-50-8	788.527	50.94	51.01	509563	510226
wire	non noble metal	aluminium	7429-90-5	4.370	0.28	0.28	2824	2824
encapsulation	organic material	carbon black	1333-86-4	1.245	0.08		805	
	plastics	epoxy resin	-	57.277	3.70		37014	
	inorganic material	silicondioxide	60676-86-0	564.051	36.45	40.23	364503	402322
leadfinish	non noble metal	tin	7440-31-5	10.339	0.67	0.67	6682	6682
plating	inorganic material	phosphorus	7723-14-0	0.008			5	
	non noble metal	nickel	7440-02-0	3.422	0.22	0.22	2211	2216
solder	non noble metal	tin	7440-31-5	0.081	0.01		52	
	noble metal	silver	7440-22-4	0.101	0.01		65	
	non noble metal	lead	7439-92-1	3.858	0.25	0.27	2493	2610
heatspreader	inorganic material	phosphorus	7723-14-0	0.032			21	
	non noble metal	iron	7439-89-6	0.108	0.01		70	
	non noble metal	copper	7440-50-8	107.943	6.98	6.99	69755	69846
*deviation	< 10%	Sum in total:				100.00		1000000

### Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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